

Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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EFS ID: 19474  
Application ID: 10065609  
Title of Invention: FLUID INJECTION HEAD  
STRUCTURE AND METHOD FOR  
MANUFACTURING THE SAME  
First Named Inventor: Tsung-Wei Huang  
Domestic/Foreign Application: Domestic Application  
Filing Date: null  
Effective Receipt Date: 2002-11-03  
Submission Type: Utility Patent Filing  
Filing Type: new-utility  
Confirmation Number: 0  
Attorney Docket Number: ACMP0021USA  
Digital Certificate Holder: cn=Winston Hsu, ou=Registered Attorneys, ou=Patent and  
Trademark Office, ou=Department of Commerce, o=U.S.  
Government, c=US  
Certificate Message Digest: Sc23Xq1N/gUGya9VdcCgww==  
Total Fees Authorized: \$870.0  
Payment Category: DA - Deposit Account  
Deposit Account Number: 500801  
Deposit Account Name: WINSTON HSU



# TRANSMITTAL FORM



Electronic Version 1.0.3

Stylesheet Version: 1.0

Attorney Docket  
Number:

ACMP0021USA

Submission Type: Utility  
Patent Filing

## FLUID INJECTION HEAD STRUCTURE AND METHOD FOR MANUFACTURING THE SAME

First Named Inventor: Tsung-Wei Huang

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**Attached Files:**

declaration	ACMP0021DEC1.TIF
declaration	ACMP0021DEC2.TIF
declaration	ACMP0021DEC3.TIF
small-entity	ACMP0021DEC4.tif
specification	ACMP0021.xml
bid-transmittal	ACMP0021apds.xml
patent-assignments	ACMP0021asgn.xml
fee-transmittal	ACMP0021fee.xml

**Attached Image File(s):**

ACMP0021DEC1.TIF  
ACMP0021DEC2.TIF  
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ACMP0021DEC4.tif

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